

# HCS70R1K1S

## 700V N-Channel Super Junction MOSFET

### Features

- Very Low FOM ( $R_{DS(on)} \times Q_g$ )
- Extremely low switching loss
- Excellent stability and uniformity
- 100% Avalanche Tested
- Built-in ESD Diode

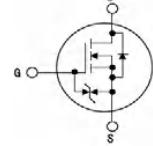
### Key Parameters

Parameter	Value	Unit
$BV_{DSS} @ T_{j,max}$	750	V
$I_D$	4.5	A
$R_{DS(on)}, \text{max}$	1.1	$\Omega$
$Q_g, \text{Typ}$	9.3	nC

### Application

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- TV power & LED Lighting Power
- AC to DC Converters
- Telecom

### Package & Internal Circuit

TO-220FS	SYMBOL
	

### Absolute Maximum Ratings

$T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Value	Unit
$V_{DSS}$	Drain-Source Voltage	700	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ )	4.5 *	A
	Drain Current - Continuous ( $T_C = 100^\circ\text{C}$ )	2.9 *	A
$I_{DM}^1)$	Drain Current - Pulsed	13.6 *	A
$E_{AS}^2)$	Single Pulsed Avalanche Energy	35	mJ
$I_{AR}$	Avalanche Current	0.9	A
$dv/dt$	MOSFET $dv/dt$ ruggedness, $V_{DS}=0\dots 400\text{V}$	50	V/ns
$dv/dt$	Reverse diode $dv/dt$ , $V_{DS}=0\dots 400\text{V}$ , $I_{DS} \leq I_D$	15	V/ns
$P_D$	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	25	W
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

\* Drain current limited by maximum junction temperature

### Thermal Resistance Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	5.0	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient , Max.	80	$^\circ\text{C}/\text{W}$

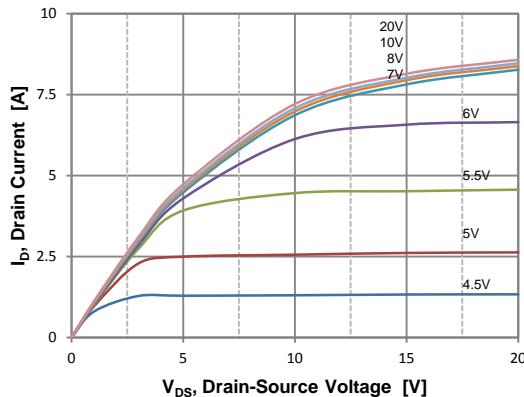
**Electrical Characteristics**  $T_J=25\text{ }^{\circ}\text{C}$  unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>On Characteristics</b>						
$V_{GS}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 140\text{ }\mu\text{A}$	2.0	-	4.0	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}$ , $I_D = 1.2\text{ A}$	-	0.955	1.1	$\Omega$
<b>Off Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}$ , $I_D = 1\text{ mA}$	700	-	-	V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 700\text{ V}$ , $V_{GS} = 0$	-	-	1	$\mu\text{A}$
		$V_{DS} = 700\text{ V}$ , $T_C = 150^{\circ}\text{C}$	-	-	100	$\mu\text{A}$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS} = \pm 20\text{ V}$ , $V_{DS} = 0\text{ V}$	-	-	$\pm 1$	$\mu\text{A}$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS} = 400\text{ V}$ , $V_{GS} = 0\text{ V}$ , $f = 1.0\text{ MHz}$	-	410	-	pF
$C_{oss}$	Output Capacitance		-	13	-	pF
$C_{rss}$	Reverse Transfer Capacitance		-	2.7	-	pF
<b>Switching Characteristics</b>						
$t_{d(on)}$	Turn-On Time	$V_{DS} = 350\text{ V}$ , $I_D = 1.8\text{ A}$ , $R_G = 25\text{ }\Omega$ (Note 3,4)	-	20	-	ns
$t_r$	Turn-On Rise Time		-	18	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	54	-	ns
$t_f$	Turn-Off Fall Time		-	19	-	ns
$Q_{g(}}$	Total Gate Charge	$V_{DS} = 560\text{ V}$ , $I_D = 1.8\text{ A}$ , $V_{GS} = 10\text{ V}$ (Note 3,4)	-	9.3	-	nC
$Q_{gs}$	Gate-Source Charge		-	1.8	-	nC
$Q_{gd}$	Gate-Drain Charge		-	3.0	-	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_S$	Maximum Continuous Drain-Source Diode Forward Current	-	-	4.5	A	
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current	-	-	13.6	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}$ , $I_S = 1.8\text{ A}$	-	-	1.3	V
$trr$	Reverse Recovery Time	$V_R = 400\text{ V}$ , $I_F = 1.8\text{ A}$ $dI_F/dt = 100\text{ A}/\mu\text{s}$	-	210	-	ns
$Qrr$	Reverse Recovery Charge		-	1.2	-	$\mu\text{C}$

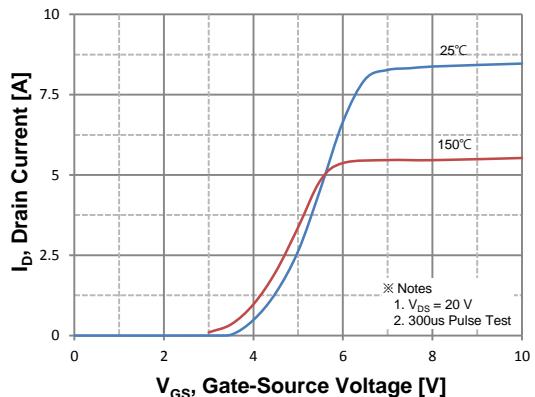
**Notes :**

- Repetitive Rating : Pulse width limited by maximum junction temperature
- $I_{AS}=0.9\text{ A}$   $V_{DD}=50\text{ V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^{\circ}\text{C}$
- Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$
- Essentially Independent of Operating Temperature

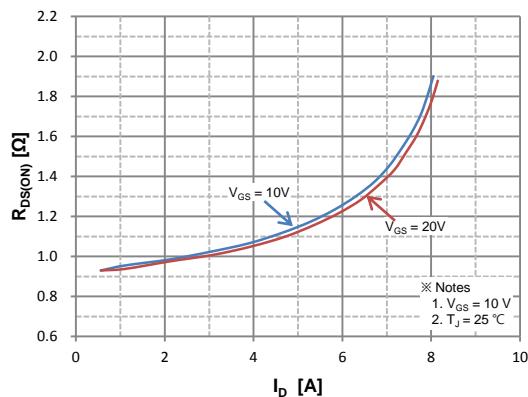
## Typical Characteristics



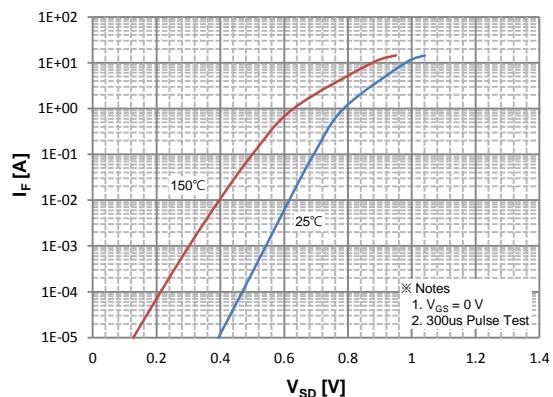
**Figure 1. On Region Characteristics**



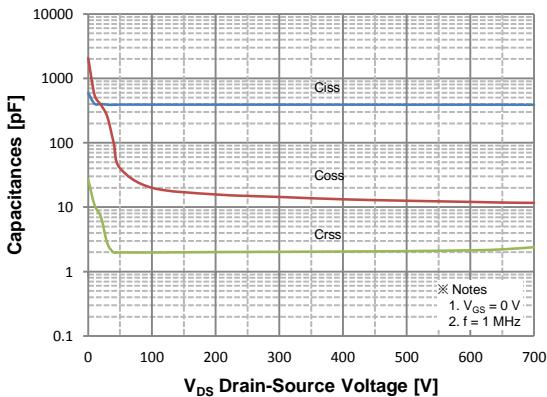
**Figure 2. Transfer Characteristics**



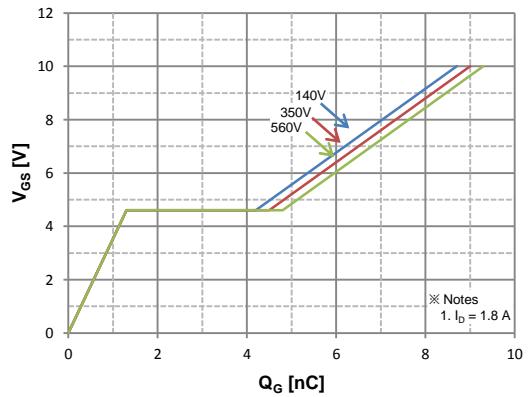
**Figure 3. On Resistance Variation vs Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**

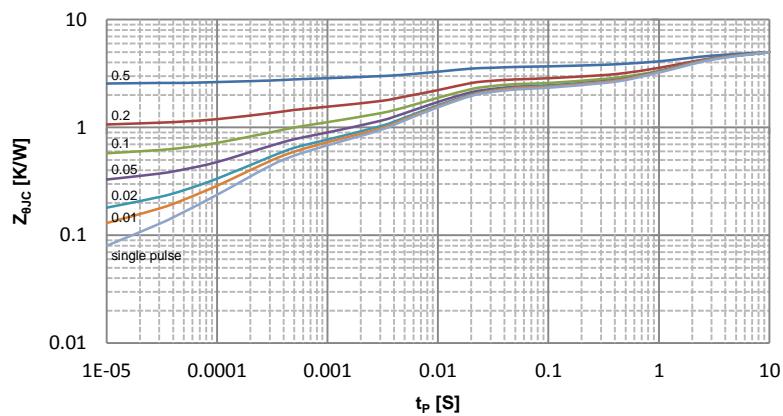
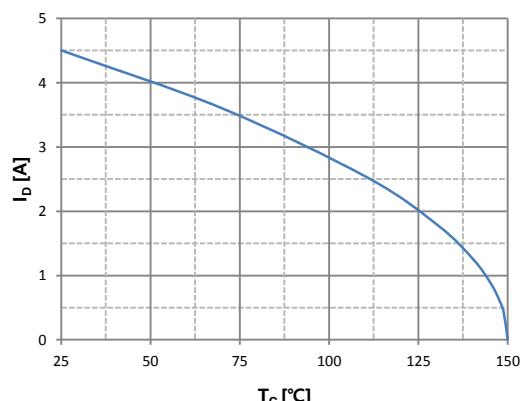
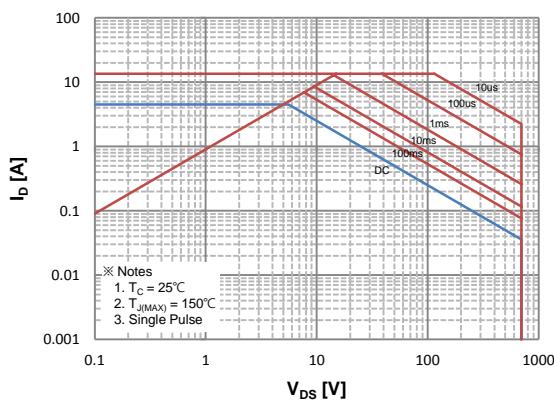
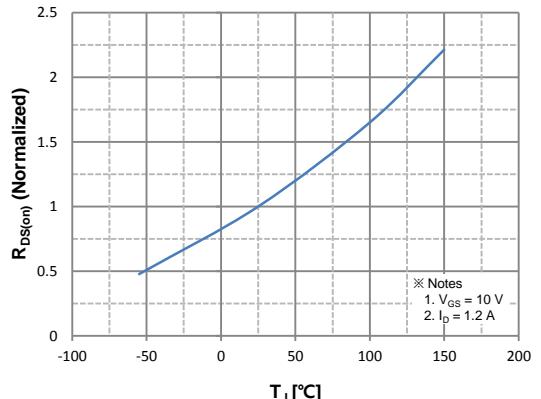
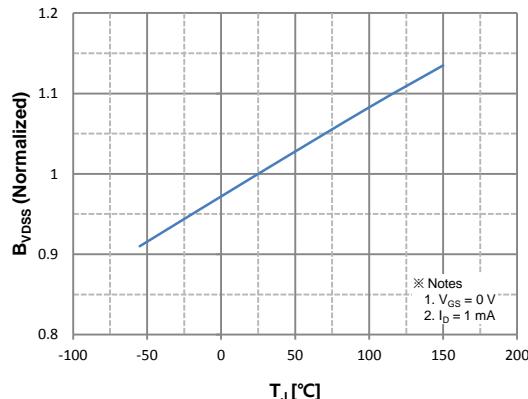


**Figure 5. Capacitance Characteristics**

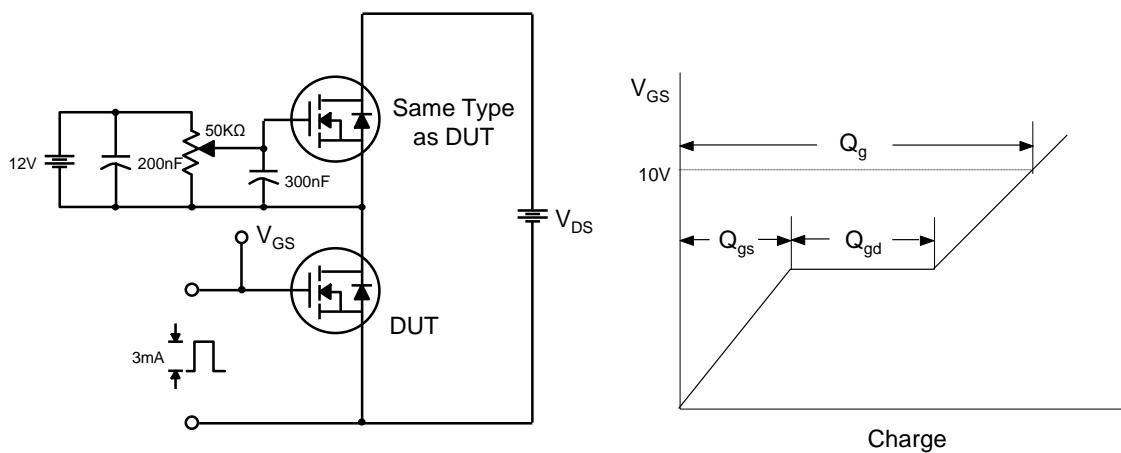


**Figure 6. Gate Charge Characteristics**

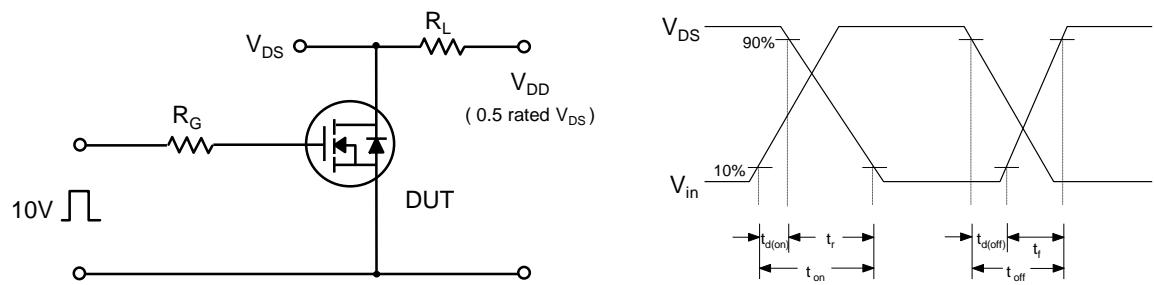
## Typical Characteristics



**Fig 12. Gate Charge Test Circuit & Waveform**



**Fig 13. Resistive Switching Test Circuit & Waveforms**



**Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**

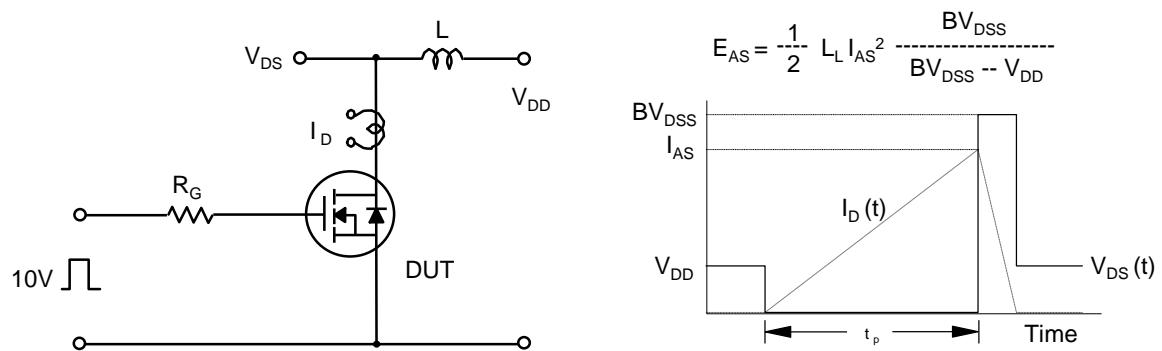
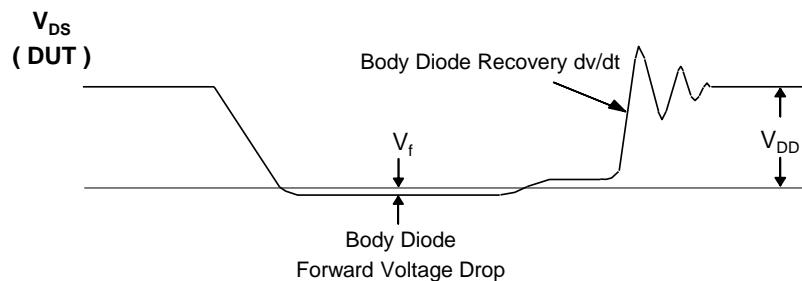
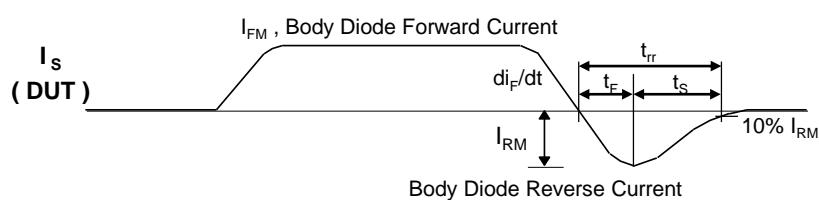
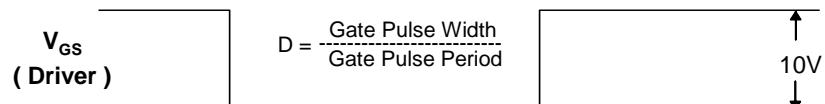
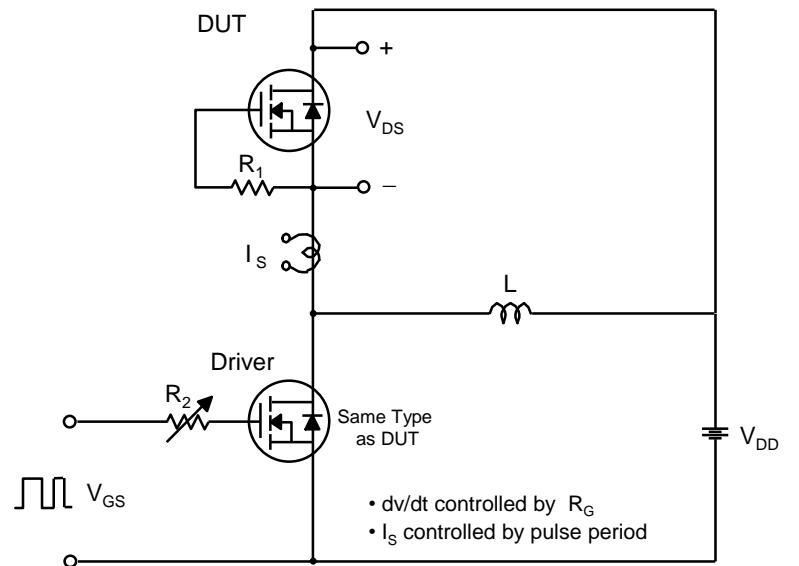


Fig 15. Peak Diode Recovery dv/dt Test Circuit &amp; Waveforms



## Package Dimension

## TO-220FS-FM(Full Mold)

